

# 74LVC2G126

Dual bus buffer/line driver; 3-state

Rev. 12 — 8 April 2013

Product data sheet

## 1. General description

The 74LVC2G126 is a dual non-inverting buffer/line driver with 3-state outputs. Each 3-state output is controlled by an output enable input (pin nOE). A LOW-level at pin nOE causes the output to assume a high-impedance OFF-state. Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of the 74LVC2G126 as a translator in a mixed 3.3 V and 5 V environment.

It is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

## 2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant input/output for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - ◆ JESD8-5 (2.3 V to 2.7 V)
  - ◆ JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
- $\pm 24$  mA output drive ( $V_{CC} = 3.0$  V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from  $-40$  °C to  $+85$  °C and  $-40$  °C to  $+125$  °C



### 3. Ordering information

Table 1. Ordering information

| Type number  | Package           |        |                                                                                             |          |
|--------------|-------------------|--------|---------------------------------------------------------------------------------------------|----------|
|              | Temperature range | Name   | Description                                                                                 | Version  |
| 74LVC2G126DP | –40 °C to +125 °C | TSSOP8 | plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm     | SOT505-2 |
| 74LVC2G126DC | –40 °C to +125 °C | VSSOP8 | plastic very thin shrink small outline package; 8 leads; body width 2.3 mm                  | SOT765-1 |
| 74LVC2G126GT | –40 °C to +125 °C | XSON8  | plastic extremely thin small outline package; no leads; 8 terminals; body 1 × 1.95 × 0.5 mm | SOT833-1 |
| 74LVC2G126GF | –40 °C to +125 °C | XSON8  | extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1 × 0.5 mm         | SOT1089  |
| 74LVC2G126GD | –40 °C to +125 °C | XSON8  | plastic extremely thin small outline package; no leads; 8 terminals; body 3 × 2 × 0.5 mm    | SOT996-2 |
| 74LVC2G126GM | –40 °C to +125 °C | XQFN8  | plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 × 1.6 × 0.5 mm   | SOT902-2 |
| 74LVC2G126GN | –40 °C to +125 °C | XSON8  | extremely thin small outline package; no leads; 8 terminals; body 1.2 × 1.0 × 0.35 mm       | SOT1116  |
| 74LVC2G126GS | –40 °C to +125 °C | XSON8  | extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1.0 × 0.35 mm      | SOT1203  |

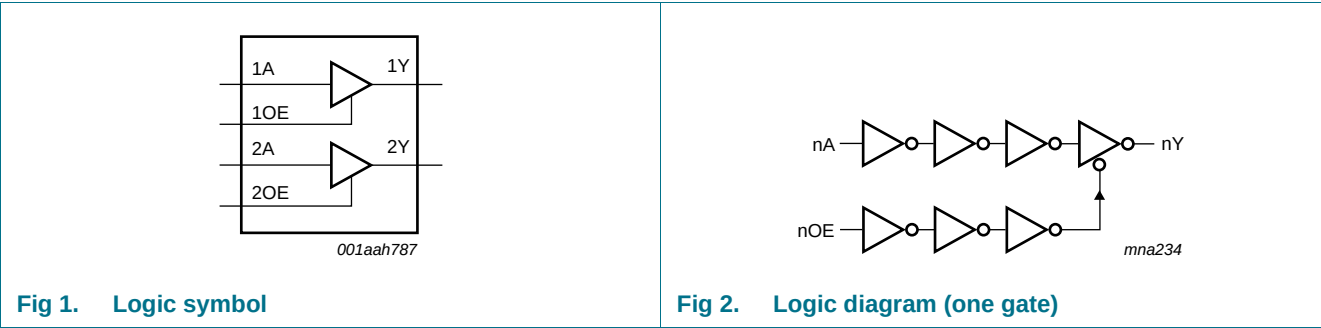
### 4. Marking

Table 2. Marking codes

| Type number  | Marking code <sup>[1]</sup> |
|--------------|-----------------------------|
| 74LVC2G126DP | V26                         |
| 74LVC2G126DC | V26                         |
| 74LVC2G126GT | V26                         |
| 74LVC2G126GF | VN                          |
| 74LVC2G126GD | V26                         |
| 74LVC2G126GM | V26                         |
| 74LVC2G126GN | VN                          |
| 74LVC2G126GS | VN                          |

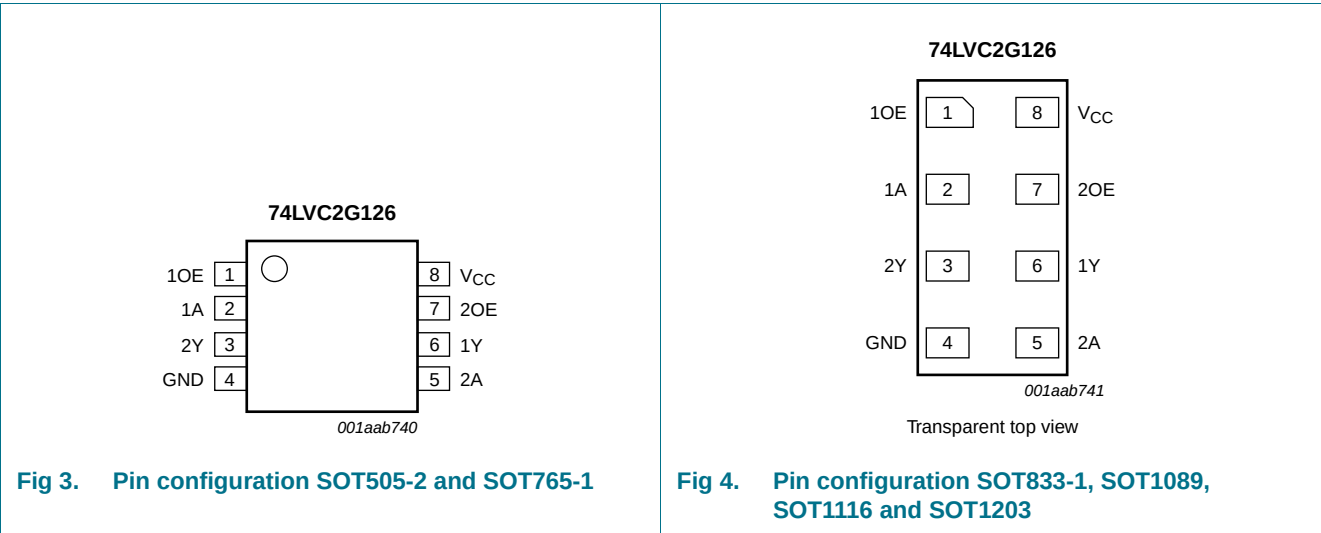
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

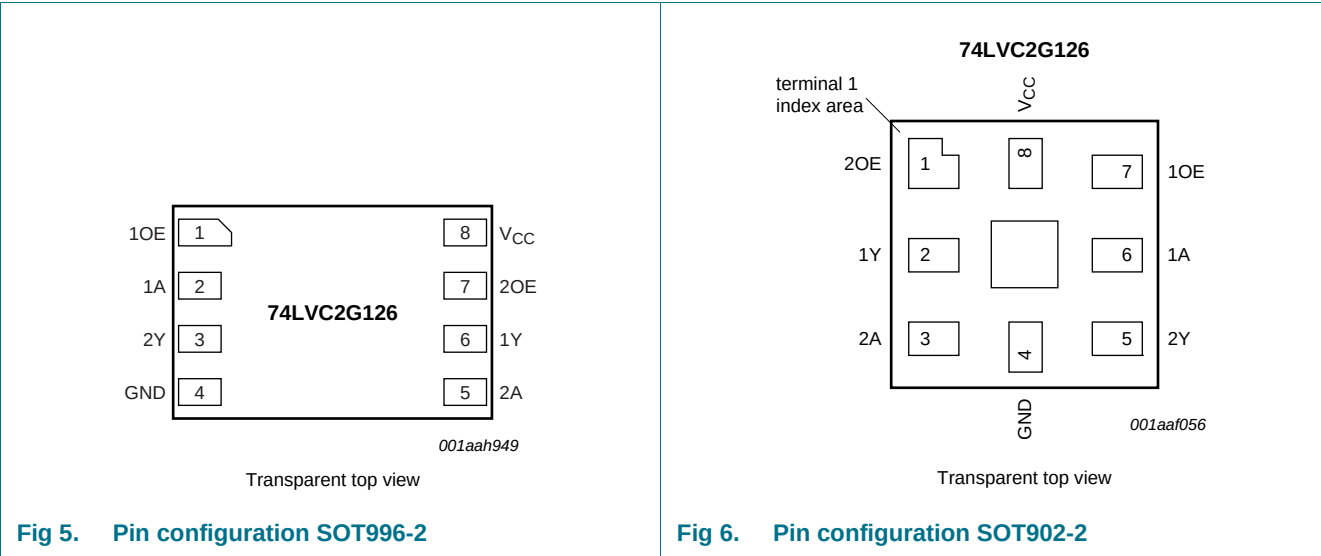
## 5. Functional diagram



## 6. Pinning information

### 6.1 Pinning





6.2 Pin description

Table 3. Pin description

| Symbol          | Pin                                                                  |          | Description                       |
|-----------------|----------------------------------------------------------------------|----------|-----------------------------------|
|                 | SOT505-2, SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203 | SOT902-2 |                                   |
| 1OE, 2OE        | 1, 7                                                                 | 7, 1     | output enable input (active HIGH) |
| 1A, 2A          | 2, 5                                                                 | 6, 3     | data input                        |
| 1Y, 2Y          | 6, 3                                                                 | 2, 5     | data output                       |
| GND             | 4                                                                    | 4        | ground (0 V)                      |
| V <sub>CC</sub> | 8                                                                    | 8        | supply voltage                    |

7. Functional description

Table 4. Function table<sup>[1]</sup>

| Input |    | Output |
|-------|----|--------|
| nOE   | nA | nY     |
| H     | L  | L      |
| H     | H  | H      |
| L     | X  | Z      |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                    | Min         | Max            | Unit |
|-----------|-------------------------|-------------------------------|-------------|----------------|------|
| $V_{CC}$  | supply voltage          |                               | -0.5        | +6.5           | V    |
| $I_{IK}$  | input clamping current  | $V_I < 0$ V                   | -50         | -              | mA   |
| $V_I$     | input voltage           |                               | [1] -0.5    | +6.5           | V    |
| $I_{OK}$  | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V | -           | $\pm 50$       | mA   |
| $V_O$     | output voltage          | Active mode                   | [1] -0.5    | $V_{CC} + 0.5$ | V    |
|           |                         | Power-down mode               | [1][2] -0.5 | +6.5           | V    |
| $I_O$     | output current          | $V_O = 0$ V to $V_{CC}$       | -           | $\pm 50$       | mA   |
| $I_{CC}$  | supply current          |                               | -           | +100           | mA   |
| $I_{GND}$ | ground current          |                               | -100        | -              | mA   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ °C to +125 °C | [3] -       | 300            | mW   |
| $T_{stg}$ | storage temperature     |                               | -65         | +150           | °C   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When  $V_{CC} = 0$  V (Power-down mode), the output voltage can be 5.5 V in normal operation.

[3] For TSSOP8 packages: above 55 °C the value of  $P_{tot}$  derates linearly at 2.5 mW/K.  
 For VSSOP8 packages: above 110 °C the value of  $P_{tot}$  derates linearly at 8.0 mW/K.  
 For XSON8 and XQFN8 packages: above 118 °C the value of  $P_{tot}$  derates linearly with 7.8 mW/K.

## 9. Recommended operating conditions

**Table 6. Operating conditions**

| Symbol              | Parameter                           | Conditions                      | Min  | Max      | Unit |
|---------------------|-------------------------------------|---------------------------------|------|----------|------|
| $V_{CC}$            | supply voltage                      |                                 | 1.65 | 5.5      | V    |
| $V_I$               | input voltage                       |                                 | 0    | 5.5      | V    |
| $V_O$               | output voltage                      | Active mode                     | 0    | $V_{CC}$ | V    |
|                     |                                     | $V_{CC} = 0$ V; Power-down mode | 0    | 5.5      | V    |
| $T_{amb}$           | ambient temperature                 |                                 | -40  | +125     | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 1.65$ V to 2.7 V      | -    | 20       | ns/V |
|                     |                                     | $V_{CC} = 2.7$ V to 5.5 V       | -    | 10       | ns/V |

## 10. Static characteristics

**Table 7. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol                                    | Parameter                 | Conditions                                                                                                   | Min                    | Typ <sup>(1)</sup> | Max                    | Unit |
|-------------------------------------------|---------------------------|--------------------------------------------------------------------------------------------------------------|------------------------|--------------------|------------------------|------|
| <b>T<sub>amb</sub> = –40 °C to +85 °C</b> |                           |                                                                                                              |                        |                    |                        |      |
| V <sub>IH</sub>                           | HIGH-level input voltage  | V <sub>CC</sub> = 1.65 V to 1.95 V                                                                           | 0.65 × V <sub>CC</sub> | -                  | -                      | V    |
|                                           |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                                                                             | 1.7                    | -                  | -                      | V    |
|                                           |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                                                                             | 2.0                    | -                  | -                      | V    |
|                                           |                           | V <sub>CC</sub> = 4.5 V to 5.5 V                                                                             | 0.7 × V <sub>CC</sub>  | -                  | -                      | V    |
| V <sub>IL</sub>                           | LOW-level input voltage   | V <sub>CC</sub> = 1.65 V to 1.95 V                                                                           | -                      | -                  | 0.35 × V <sub>CC</sub> | V    |
|                                           |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                                                                             | -                      | -                  | 0.7                    | V    |
|                                           |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                                                                             | -                      | -                  | 0.8                    | V    |
|                                           |                           | V <sub>CC</sub> = 4.5 V to 5.5 V                                                                             | -                      | -                  | 0.3 × V <sub>CC</sub>  | V    |
| V <sub>OL</sub>                           | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                          |                        |                    |                        |      |
|                                           |                           | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V                                                   | -                      | -                  | 0.1                    | V    |
|                                           |                           | I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V                                                              | -                      | -                  | 0.45                   | V    |
|                                           |                           | I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V                                                               | -                      | -                  | 0.3                    | V    |
|                                           |                           | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V                                                              | -                      | -                  | 0.4                    | V    |
|                                           |                           | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V                                                              | -                      | -                  | 0.55                   | V    |
|                                           |                           | I <sub>O</sub> = 32 mA; V <sub>CC</sub> = 4.5 V                                                              | -                      | -                  | 0.55                   | V    |
| V <sub>OH</sub>                           | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                          |                        |                    |                        |      |
|                                           |                           | I <sub>O</sub> = –100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V                                                  | V <sub>CC</sub> – 0.1  | -                  | -                      | V    |
|                                           |                           | I <sub>O</sub> = –4 mA; V <sub>CC</sub> = 1.65 V                                                             | 1.2                    | -                  | -                      | V    |
|                                           |                           | I <sub>O</sub> = –8 mA; V <sub>CC</sub> = 2.3 V                                                              | 1.9                    | -                  | -                      | V    |
|                                           |                           | I <sub>O</sub> = –12 mA; V <sub>CC</sub> = 2.7 V                                                             | 2.2                    | -                  | -                      | V    |
|                                           |                           | I <sub>O</sub> = –24 mA; V <sub>CC</sub> = 3.0 V                                                             | 2.3                    | -                  | -                      | V    |
| I <sub>I</sub>                            | input leakage current     | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V                                                | -                      | ±0.1               | ±5                     | µA   |
|                                           |                           | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = 5.5 V or GND; V <sub>CC</sub> = 3.6 V | -                      | ±0.1               | ±10                    | µA   |
| I <sub>OFF</sub>                          | power-off leakage current | V <sub>I</sub> or V <sub>O</sub> = 5.5 V; V <sub>CC</sub> = 0 V                                              | -                      | ±0.1               | ±10                    | µA   |
| I <sub>CC</sub>                           | supply current            | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 1.65 V to 5.5 V; I <sub>O</sub> = 0 A                       | -                      | 0.1                | 10                     | µA   |
| ΔI <sub>CC</sub>                          | additional supply current | per pin; V <sub>I</sub> = V <sub>CC</sub> – 0.6 V; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 2.3 V to 5.5 V    | -                      | 5                  | 500                    | µA   |
| C <sub>I</sub>                            | input capacitance         |                                                                                                              | -                      | 2                  | -                      | pF   |

**Table 7.** Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol                                     | Parameter                 | Conditions                                                                                                   | Min                    | Typ <sup>[1]</sup> | Max                    | Unit |
|--------------------------------------------|---------------------------|--------------------------------------------------------------------------------------------------------------|------------------------|--------------------|------------------------|------|
| <b>T<sub>amb</sub> = -40 °C to +125 °C</b> |                           |                                                                                                              |                        |                    |                        |      |
| V <sub>IH</sub>                            | HIGH-level input voltage  | V <sub>CC</sub> = 1.65 V to 1.95 V                                                                           | 0.65 × V <sub>CC</sub> | -                  | -                      | V    |
|                                            |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                                                                             | 1.7                    | -                  | -                      | V    |
|                                            |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                                                                             | 2.0                    | -                  | -                      | V    |
|                                            |                           | V <sub>CC</sub> = 4.5 V to 5.5 V                                                                             | 0.7 × V <sub>CC</sub>  | -                  | -                      | V    |
| V <sub>IL</sub>                            | LOW-level input voltage   | V <sub>CC</sub> = 1.65 V to 1.95 V                                                                           | -                      | -                  | 0.35 × V <sub>CC</sub> | V    |
|                                            |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                                                                             | -                      | -                  | 0.7                    | V    |
|                                            |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                                                                             | -                      | -                  | 0.8                    | V    |
|                                            |                           | V <sub>CC</sub> = 4.5 V to 5.5 V                                                                             | -                      | -                  | 0.3 × V <sub>CC</sub>  | V    |
| V <sub>OL</sub>                            | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                          |                        |                    |                        |      |
|                                            |                           | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V                                                   | -                      | -                  | 0.1                    | V    |
|                                            |                           | I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V                                                              | -                      | -                  | 0.70                   | V    |
|                                            |                           | I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V                                                               | -                      | -                  | 0.45                   | V    |
|                                            |                           | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V                                                              | -                      | -                  | 0.60                   | V    |
|                                            |                           | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V                                                              | -                      | -                  | 0.80                   | V    |
|                                            |                           | I <sub>O</sub> = 32 mA; V <sub>CC</sub> = 4.5 V                                                              | -                      | -                  | 0.80                   | V    |
| V <sub>OH</sub>                            | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                          |                        |                    |                        |      |
|                                            |                           | I <sub>O</sub> = -100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V                                                  | V <sub>CC</sub> - 0.1  | -                  | -                      | V    |
|                                            |                           | I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V                                                             | 0.95                   | -                  | -                      | V    |
|                                            |                           | I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V                                                              | 1.7                    | -                  | -                      | V    |
|                                            |                           | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V                                                             | 1.9                    | -                  | -                      | V    |
|                                            |                           | I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V                                                             | 2.0                    | -                  | -                      | V    |
|                                            |                           | I <sub>O</sub> = -32 mA; V <sub>CC</sub> = 4.5 V                                                             | 3.4                    | -                  | -                      | V    |
| I <sub>I</sub>                             | input leakage current     | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V                                                | -                      | -                  | ±20                    | µA   |
| I <sub>OZ</sub>                            | OFF-state output current  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = 5.5 V or GND; V <sub>CC</sub> = 3.6 V | -                      | -                  | ±20                    | µA   |
| I <sub>OFF</sub>                           | power-off leakage current | V <sub>I</sub> or V <sub>O</sub> = 5.5 V; V <sub>CC</sub> = 0 V                                              | -                      | -                  | ±20                    | µA   |
| I <sub>CC</sub>                            | supply current            | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 1.65 V to 5.5 V; I <sub>O</sub> = 0 A                       | -                      | -                  | 40                     | µA   |
| ΔI <sub>CC</sub>                           | additional supply current | per pin; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 2.3 V to 5.5 V    | -                      | -                  | 5                      | mA   |

[1] Typical values are measured at V<sub>CC</sub> = 3.3 V and T<sub>amb</sub> = 25 °C.

## 11. Dynamic characteristics

**Table 8. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 9](#).

| Symbol           | Parameter                     | Conditions                                                         | –40 °C to +85 °C |                    |      | –40 °C to +125 °C |      | Unit |
|------------------|-------------------------------|--------------------------------------------------------------------|------------------|--------------------|------|-------------------|------|------|
|                  |                               |                                                                    | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| t <sub>pd</sub>  | propagation delay             | nA to nY; see <a href="#">Figure 7</a> <sup>[2]</sup>              |                  |                    |      |                   |      |      |
|                  |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                 | 1.0              | 3.9                | 9.8  | 1.0               | 12.3 | ns   |
|                  |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                   | 0.5              | 2.6                | 4.9  | 0.5               | 6.3  | ns   |
|                  |                               | V <sub>CC</sub> = 2.7 V                                            | 1.0              | 2.8                | 4.7  | 1.0               | 5.9  | ns   |
|                  |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                   | 0.5              | 2.4                | 4.3  | 0.5               | 5.4  | ns   |
|                  |                               | V <sub>CC</sub> = 4.5 V to 5.5 V                                   | 0.5              | 1.9                | 3.2  | 0.5               | 4.0  | ns   |
| t <sub>en</sub>  | enable time                   | nOE to nY; see <a href="#">Figure 8</a> <sup>[3]</sup>             |                  |                    |      |                   |      |      |
|                  |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                 | 1.0              | 4.1                | 10.0 | 1.0               | 12.5 | ns   |
|                  |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                   | 1.0              | 2.6                | 5.0  | 1.0               | 6.3  | ns   |
|                  |                               | V <sub>CC</sub> = 2.7 V                                            | 1.0              | 2.8                | 4.7  | 1.0               | 5.9  | ns   |
|                  |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                   | 1.0              | 2.4                | 4.1  | 1.0               | 5.1  | ns   |
|                  |                               | V <sub>CC</sub> = 4.5 V to 5.5 V                                   | 0.5              | 1.8                | 3.1  | 0.5               | 3.9  | ns   |
| t <sub>dis</sub> | disable time                  | nOE to nY; see <a href="#">Figure 8</a> <sup>[4]</sup>             |                  |                    |      |                   |      |      |
|                  |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                 | 1.0              | 3.3                | 12.6 | 1.0               | 15.4 | ns   |
|                  |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                   | 0.5              | 1.9                | 5.7  | 0.5               | 7.5  | ns   |
|                  |                               | V <sub>CC</sub> = 2.7 V                                            | 1.5              | 3.0                | 4.8  | 1.5               | 6.2  | ns   |
|                  |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                   | 1.0              | 2.5                | 4.4  | 1.0               | 5.7  | ns   |
|                  |                               | V <sub>CC</sub> = 4.5 V to 5.5 V                                   | 0.5              | 1.8                | 3.3  | 0.5               | 4.4  | ns   |
| C <sub>PD</sub>  | power dissipation capacitance | per buffer; V <sub>I</sub> = GND to V <sub>CC</sub> <sup>[5]</sup> |                  |                    |      |                   |      |      |
|                  |                               | output enabled                                                     | -                | 17                 | -    | -                 | -    | pF   |
|                  |                               | output disabled                                                    | -                | 5                  | -    | -                 | -    | pF   |

[1] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

[2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>

[3] t<sub>en</sub> is the same as t<sub>PZH</sub> and t<sub>PZL</sub>

[4] t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>

[5] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

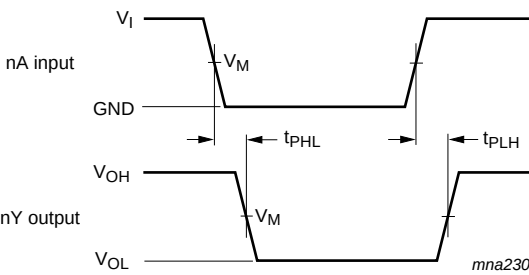
V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of outputs.

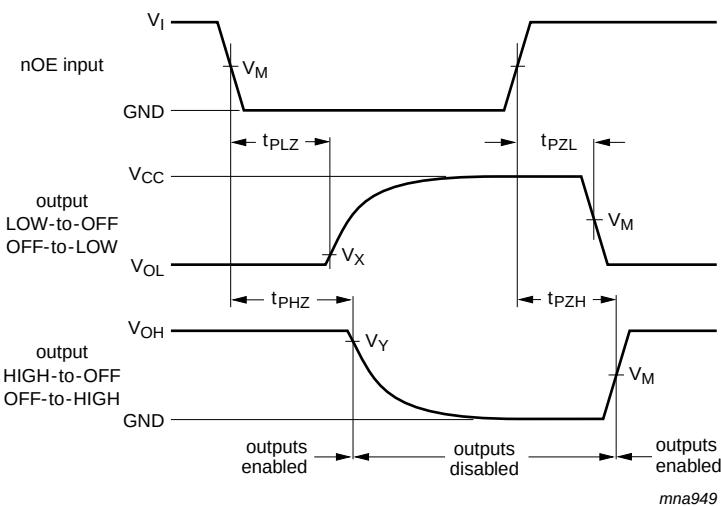


12. Waveforms



Measurement points are given in [Table 9](#).  
Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 7. The data input (nA) to output (nY) propagation delays**

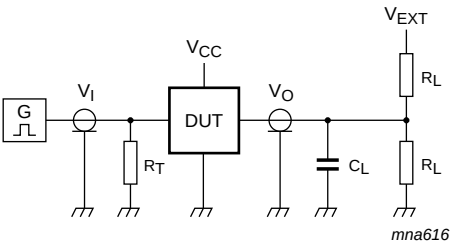


Measurement points are given in [Table 9](#).  
Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 8. 3-state enable and disable times**

**Table 9. Measurement points**

| Supply voltage   | Input               | Output              |                           |                           |
|------------------|---------------------|---------------------|---------------------------|---------------------------|
| $V_{CC}$         | $V_M$               | $V_M$               | $V_X$                     | $V_Y$                     |
| 1.65 V to 1.95 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | $V_{OL} + 0.15 \text{ V}$ | $V_{OH} - 0.15 \text{ V}$ |
| 2.3 V to 2.7 V   | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | $V_{OL} + 0.15 \text{ V}$ | $V_{OH} - 0.15 \text{ V}$ |
| 2.7 V            | 1.5 V               | 1.5 V               | $V_{OL} + 0.3 \text{ V}$  | $V_{OH} - 0.3 \text{ V}$  |
| 3.0 V to 3.6 V   | 1.5 V               | 1.5 V               | $V_{OL} + 0.3 \text{ V}$  | $V_{OH} - 0.3 \text{ V}$  |
| 4.5 V to 5.5 V   | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | $V_{OL} + 0.3 \text{ V}$  | $V_{OH} - 0.3 \text{ V}$  |



Test data is given in [Table 10](#).  
Definitions for test circuit:  
 $R_L$  = Load resistance.  
 $C_L$  = Load capacitance including jig and probe capacitance.  
 $R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.  
 $V_{EXT}$  = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

Table 10. Test data

| Supply voltage   | Input           |                                 | Load           |                | V <sub>EXT</sub>                    |                                     |                                     |
|------------------|-----------------|---------------------------------|----------------|----------------|-------------------------------------|-------------------------------------|-------------------------------------|
| V <sub>CC</sub>  | V <sub>I</sub>  | t <sub>r</sub> , t <sub>f</sub> | C <sub>L</sub> | R <sub>L</sub> | t <sub>PLH</sub> , t <sub>PHL</sub> | t <sub>PZH</sub> , t <sub>PHZ</sub> | t <sub>PZL</sub> , t <sub>PLZ</sub> |
| 1.65 V to 1.95 V | V <sub>CC</sub> | ≤ 2.0 ns                        | 30 pF          | 1 kΩ           | open                                | GND                                 | 2 × V <sub>CC</sub>                 |
| 2.3 V to 2.7 V   | V <sub>CC</sub> | ≤ 2.0 ns                        | 30 pF          | 500 Ω          | open                                | GND                                 | 2 × V <sub>CC</sub>                 |
| 2.7 V            | 2.7 V           | ≤ 2.5 ns                        | 50 pF          | 500 Ω          | open                                | GND                                 | 6 V                                 |
| 3.0 V to 3.6 V   | 2.7 V           | ≤ 2.5 ns                        | 50 pF          | 500 Ω          | open                                | GND                                 | 6 V                                 |
| 4.5 V to 5.5 V   | V <sub>CC</sub> | ≤ 2.5 ns                        | 50 pF          | 500 Ω          | open                                | GND                                 | 2 × V <sub>CC</sub>                 |

13. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm    SOT505-2

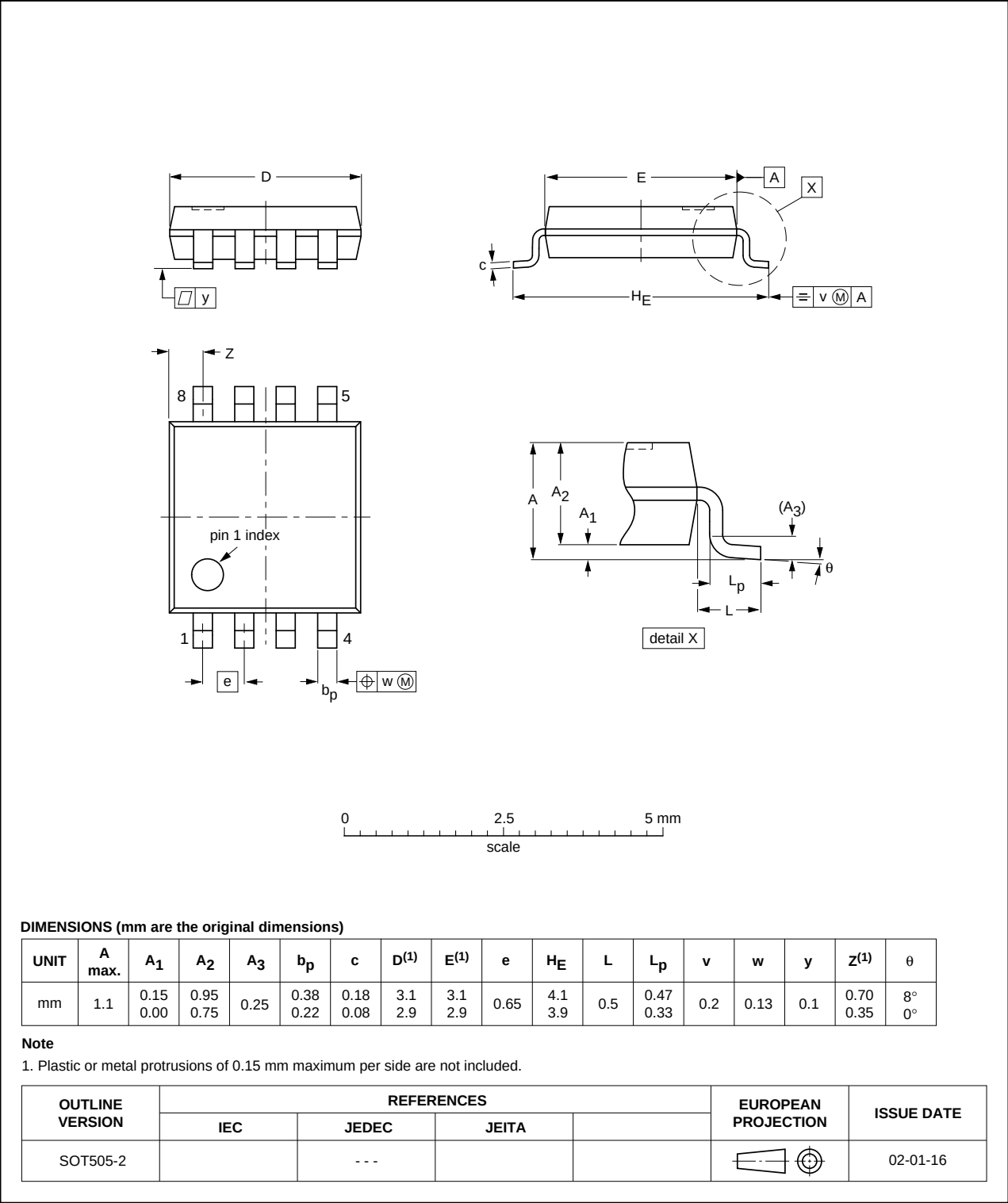


Fig 10. Package outline SOT505-2 (TSSOP8)

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1

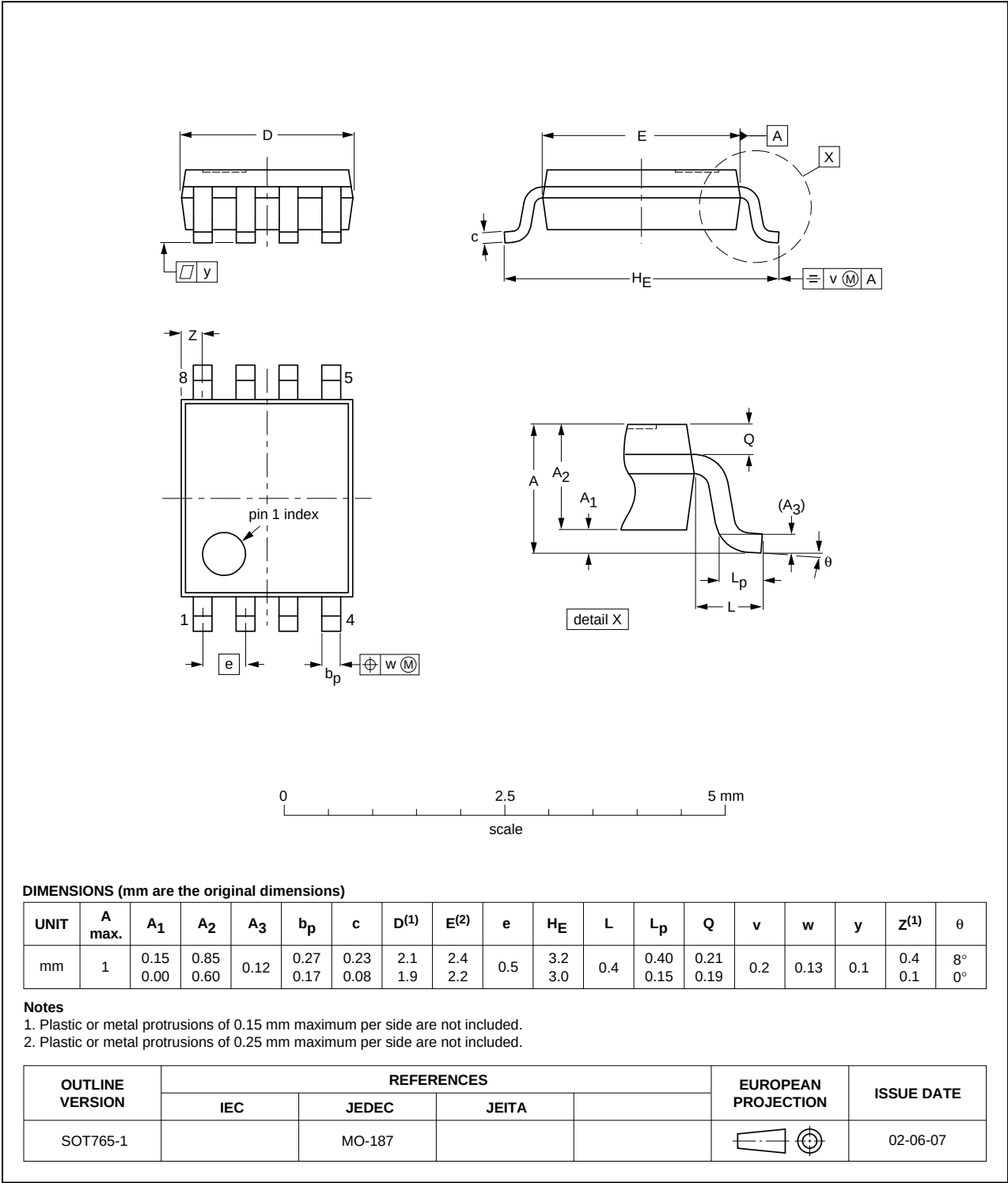


Fig 11. Package outline SOT765-1 (VSSOP8)

XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 1 x 1.95 x 0.5 mm

SOT833-1

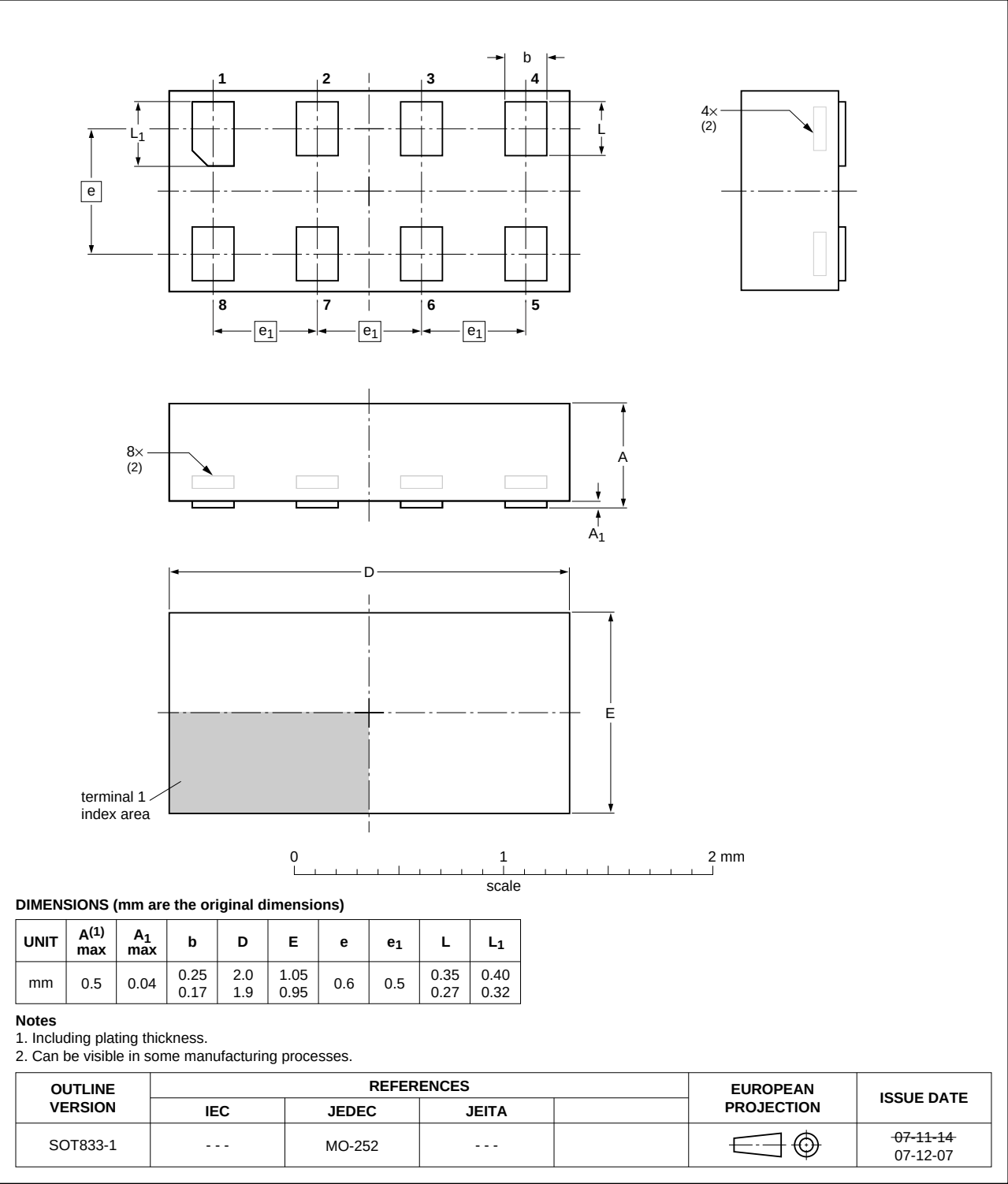


Fig 12. Package outline SOT833-1 (XSON8)

**XSON8: extremely thin small outline package; no leads;**  
**8 terminals; body 1.35 x 1 x 0.5 mm**

SOT1089

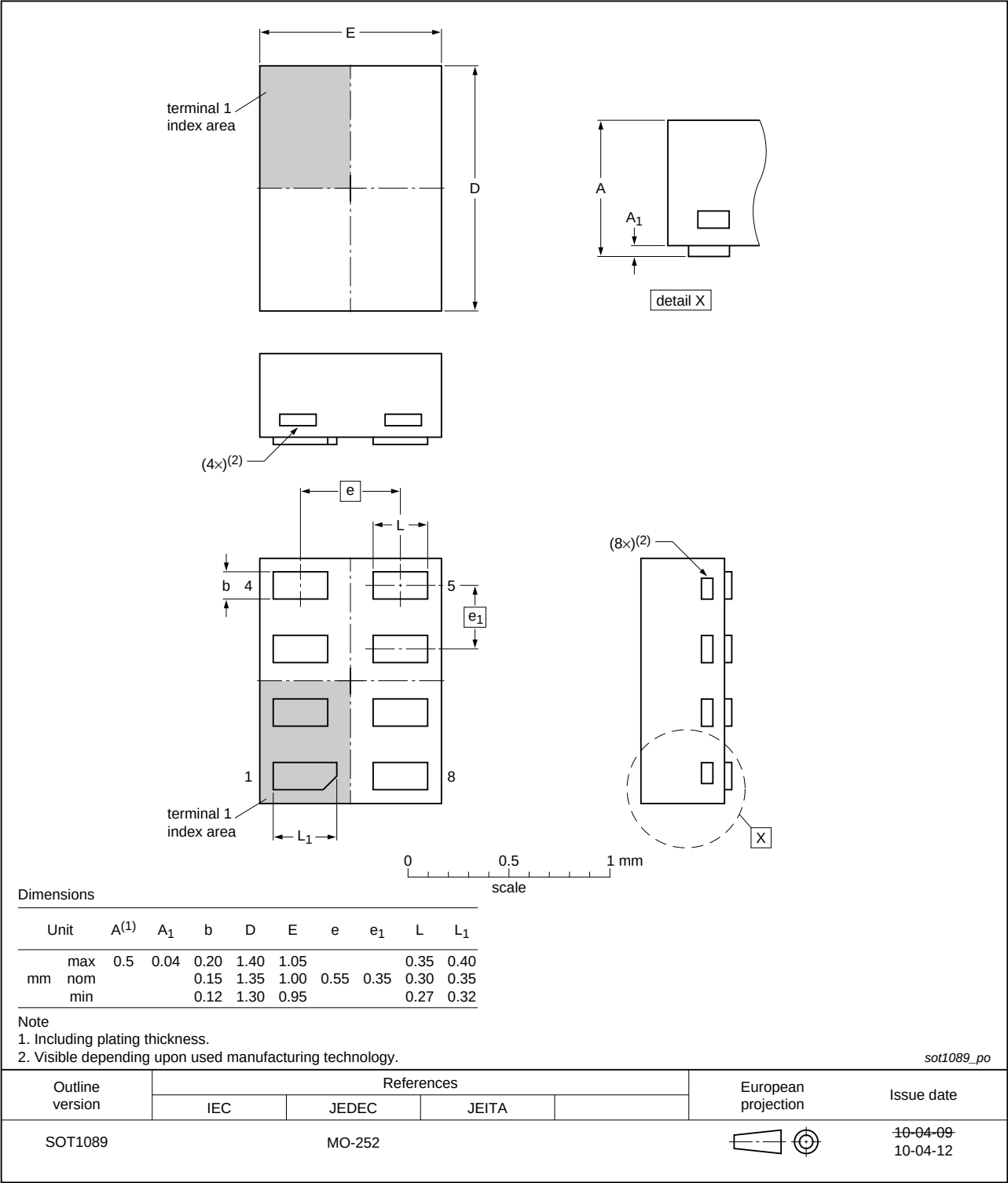


Fig 13. Package outline SOT1089 (XSON8)

XSON8: plastic extremely thin small outline package; no leads;  
8 terminals; body 3 x 2 x 0.5 mm

SOT996-2

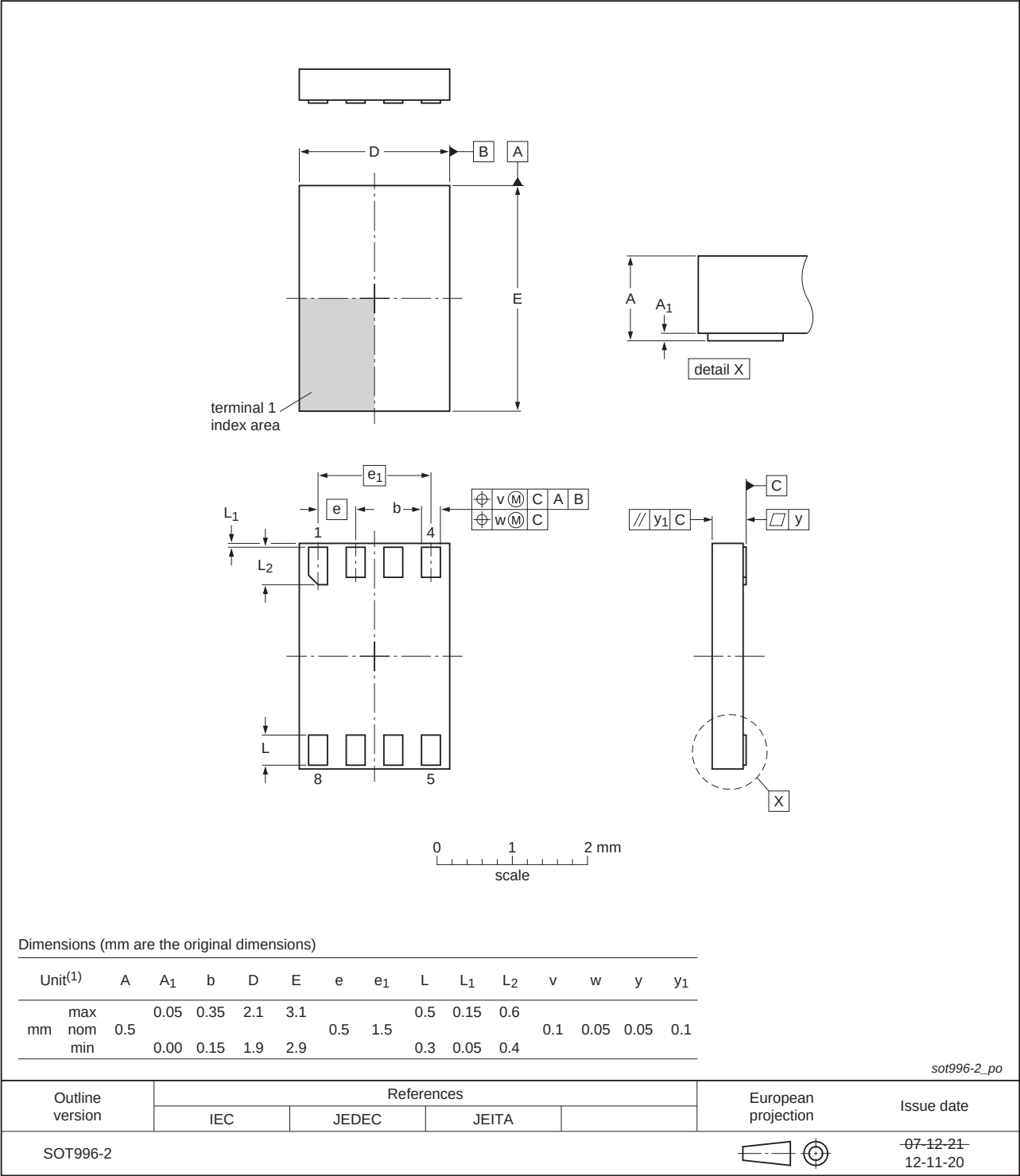


Fig 14. Package outline SOT996-2 (XSON8)

XQFN8: plastic, extremely thin quad flat package; no leads;  
8 terminals; body 1.6 x 1.6 x 0.5 mm

SOT902-2

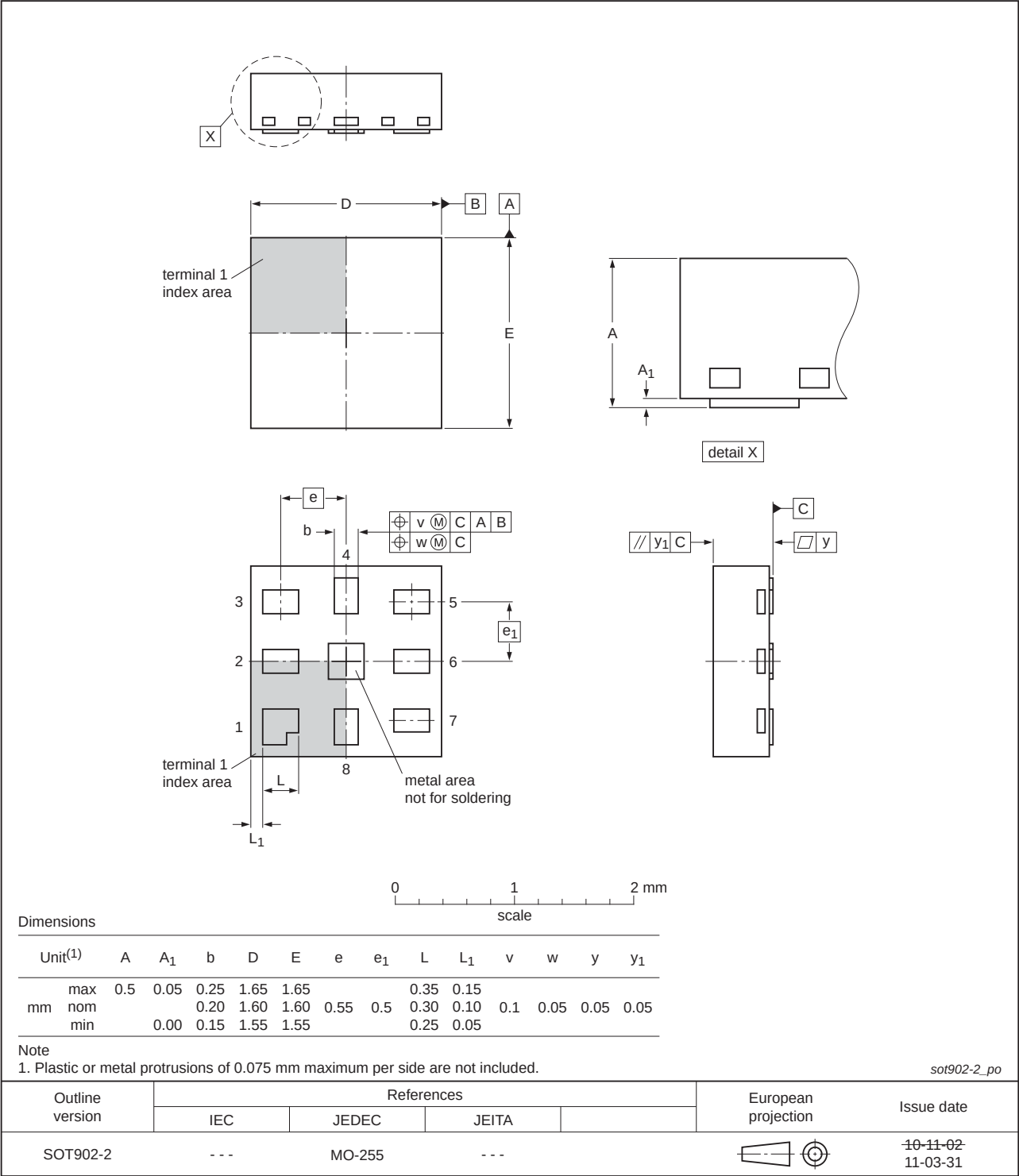


Fig 15. Package outline SOT902-2 (XQFN8)



XSON8: extremely thin small outline package; no leads;  
8 terminals; body 1.2 x 1.0 x 0.35 mm

SOT1116

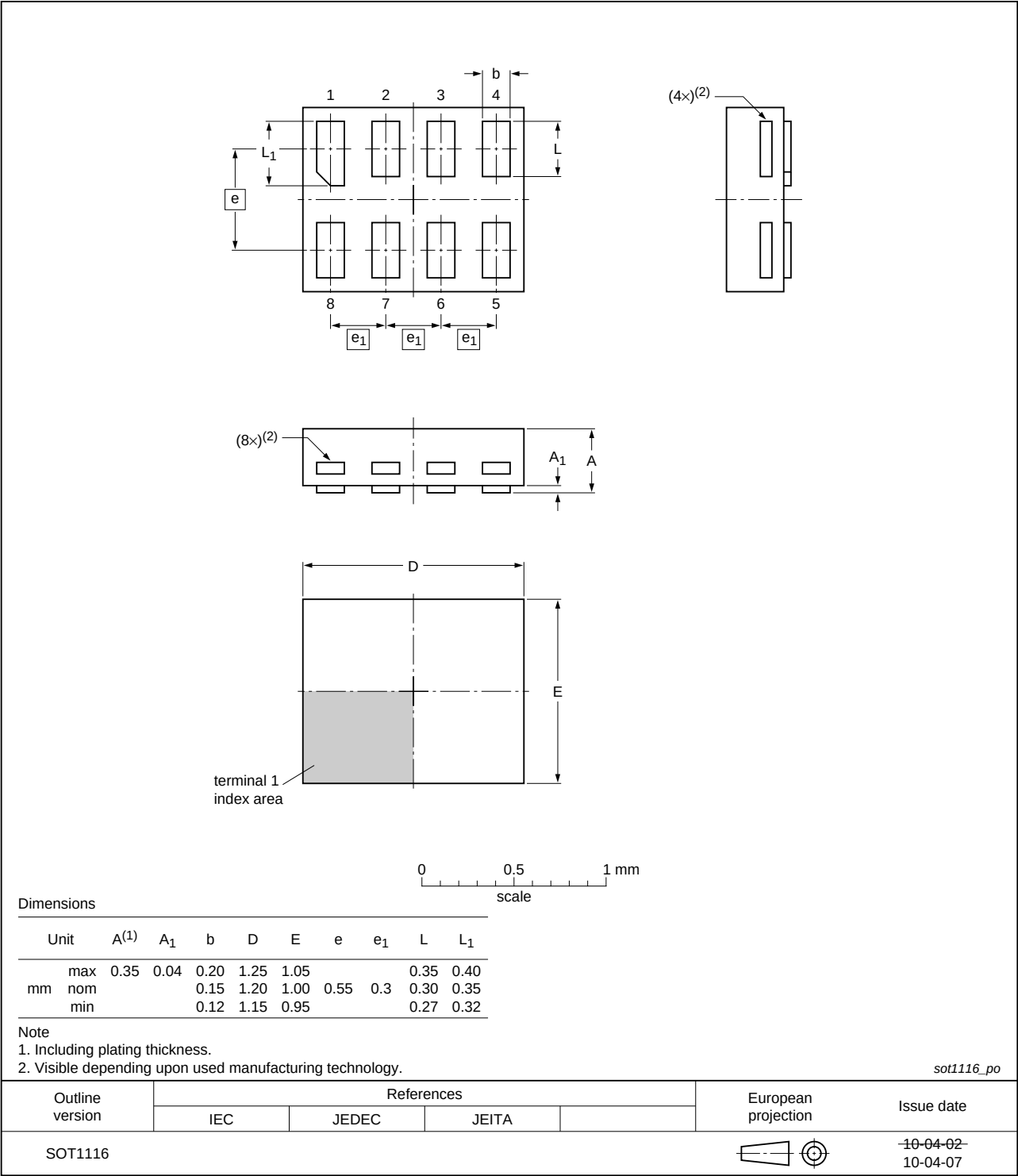


Fig 16. Package outline SOT1116 (XSON8)

XSON8: extremely thin small outline package; no leads;  
8 terminals; body 1.35 x 1.0 x 0.35 mm

SOT1203

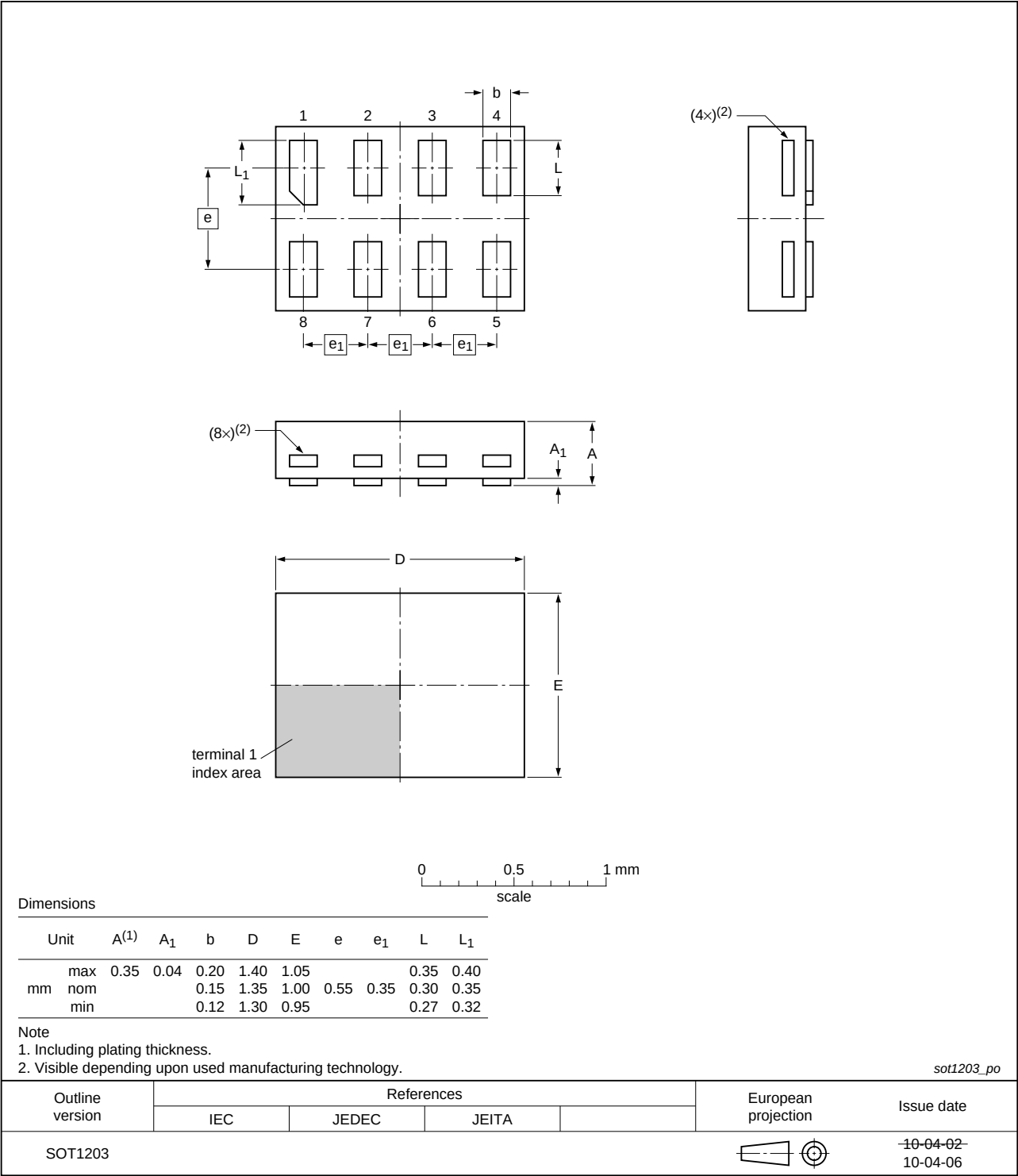


Fig 17. Package outline SOT1203 (XSON8)

## 14. Abbreviations

Table 11. Abbreviations

| Acronym | Description                             |
|---------|-----------------------------------------|
| CMOS    | Complementary Metal-Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

## 15. Revision history

Table 12. Revision history

| Document ID     | Release date                                                         | Data sheet status     | Change notice | Supersedes      |
|-----------------|----------------------------------------------------------------------|-----------------------|---------------|-----------------|
| 74LVC2G126 v.12 | 20130408                                                             | Product data sheet    | -             | 74LVC2G126 v.11 |
| Modifications:  | • For type number 74LVC2G126GD XSON8U has changed to XSON8.          |                       |               |                 |
| 74LVC2G126 v.11 | 20120622                                                             | Product data sheet    | -             | 74LVC2G126 v.10 |
| Modifications:  | • For type number 74LVC2G126GM the SOT code has changed to SOT902-2. |                       |               |                 |
| 74LVC2G126 v.10 | 20111201                                                             | Product data sheet    | -             | 74LVC2G126 v.9  |
| Modifications:  | • Legal pages updated.                                               |                       |               |                 |
| 74LVC2G126 v.9  | 20100913                                                             | Product data sheet    | -             | 74LVC2G126 v.8  |
| 74LVC2G126 v.8  | 20080505                                                             | Product data sheet    | -             | 74LVC2G126 v.7  |
| 74LVC2G126 v.7  | 20080228                                                             | Product data sheet    | -             | 74LVC2G126 v.6  |
| 74LVC2G126 v.6  | 20070907                                                             | Product data sheet    | -             | 74LVC2G126 v.5  |
| 74LVC2G126 v.5  | 20061006                                                             | Product data sheet    | -             | 74LVC2G126 v.4  |
| 74LVC2G126 v.4  | 20050201                                                             | Product specification | -             | 74LVC2G126 v.3  |
| 74LVC2G126 v.3  | 20040922                                                             | Product specification | -             | 74LVC2G126 v.2  |
| 74LVC2G126 v.2  | 20030901                                                             | Product specification | -             | 74LVC2G126 v.1  |
| 74LVC2G126 v.1  | 20030310                                                             | Product specification | -             | -               |

## 16. Legal information

### 16.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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## 18. Contents

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|           |                                               |           |
|-----------|-----------------------------------------------|-----------|
| <b>1</b>  | <b>General description</b> .....              | <b>1</b>  |
| <b>2</b>  | <b>Features and benefits</b> .....            | <b>1</b>  |
| <b>3</b>  | <b>Ordering information</b> .....             | <b>2</b>  |
| <b>4</b>  | <b>Marking</b> .....                          | <b>2</b>  |
| <b>5</b>  | <b>Functional diagram</b> .....               | <b>3</b>  |
| <b>6</b>  | <b>Pinning information</b> .....              | <b>3</b>  |
| 6.1       | Pinning .....                                 | 3         |
| 6.2       | Pin description .....                         | 4         |
| <b>7</b>  | <b>Functional description</b> .....           | <b>4</b>  |
| <b>8</b>  | <b>Limiting values</b> .....                  | <b>5</b>  |
| <b>9</b>  | <b>Recommended operating conditions</b> ..... | <b>5</b>  |
| <b>10</b> | <b>Static characteristics</b> .....           | <b>6</b>  |
| <b>11</b> | <b>Dynamic characteristics</b> .....          | <b>8</b>  |
| <b>12</b> | <b>Waveforms</b> .....                        | <b>9</b>  |
| <b>13</b> | <b>Package outline</b> .....                  | <b>11</b> |
| <b>14</b> | <b>Abbreviations</b> .....                    | <b>19</b> |
| <b>15</b> | <b>Revision history</b> .....                 | <b>19</b> |
| <b>16</b> | <b>Legal information</b> .....                | <b>20</b> |
| 16.1      | Data sheet status .....                       | 20        |
| 16.2      | Definitions .....                             | 20        |
| 16.3      | Disclaimers .....                             | 20        |
| 16.4      | Trademarks .....                              | 21        |
| <b>17</b> | <b>Contact information</b> .....              | <b>21</b> |
| <b>18</b> | <b>Contents</b> .....                         | <b>22</b> |

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